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PPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/198,849	11/24/1998	YOSHINOBU KANEYAMA	P/1929-47	3012
75	90 08/26/2003			
Steven I. Weisburd, Esq.			EXAMINER	
Dickstein Shapiro Morin & Oshinsky LLP 1177 Avenue of the Americas			ELVE, MARIA ALEXANDRA	
41st Floor New York, NY	10036-2714		ART UNIT	PAPER NUMBER
			1725	

DATE MAILED: 08/26/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Annligantial	/_1
			Applicant(s)	,
	Office Action Summers	09/198,849	KANEYAMA, YOSHINOE	3 ∪
I	Office Action Summary	Examiner	Art Unit	
		M. Alexandra Elve	1725	
Period fo	The MAILING DATE of this communication ap or Reply	pears on the cover s	heet with the correspondence address	
THE - Exte after - If the - If NC - Failu - Any I	ORTENED STATUTORY PERIOD FOR REPI MAILING DATE OF THIS COMMUNICATION, nsions of time may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication. a period for reply specified above is less than thirty (30) days, a report of or reply is specified above, the maximum statutory period reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will, by stature to reply within the set or extended period for reply will.	136(a). In no event, however ply within the statutory minimud will apply and will expire SIX te, cause the application to be	r, may a reply be timely filed um of thirty (30) days will be considered timely. (6) MONTHS from the mailing date of this communicated the co	ation.
1)⊠	Responsive to communication(s) filed on 25	June 2003 .		
2a)⊠	This action is FINAL . 2b) ☐ T	his action is non-fina	ıl.	
3) Dispositi	Since this application is in condition for allow closed in accordance with the practice unde ion of Claims			ts is
4) 🖂	Claim(s) <u>10-19,21,22 and 25-52</u> is/are pendi	ng in the application.		
	4a) Of the above claim(s) is/are withdra	awn from considerati	on.	
	Claim(s) is/are allowed.		•	
	Claim(s) <u>10-19,21,22 and 25-52</u> is/are rejected	ed.		
7)	Claim(s) is/are objected to.			
8)	Claim(s) are subject to restriction and/	or election requireme	ent.	
	ion Papers			
9) 🔲	The specification is objected to by the Examin	er.		
10)🖾	The drawing(s) filed on <u>24 November 1998</u> is/a	are: a)⊠ accepted or	b)⊡ objected to by the Examiner.	
	Applicant may not request that any objection to the	he drawing(s) be held i	n abeyance. See 37 CFR 1.85(a).	
11) 🔲 🤈	The proposed drawing correction filed on	_ is: a)□ approved	b) disapproved by the Examiner.	
	If approved, corrected drawings are required in re	eply to this Office action	1.	
12) 🗌 -	The oath or declaration is objected to by the E	xaminer.		
Priority ι	under 35 U.S.C. §§ 119 and 120			
13)🛛	Acknowledgment is made of a claim for foreig	n priority under 35 U	J.S.C. § 119(a)-(d) or (f).	
a)[☑ All b)☐ Some * c)☐ None of:			
	1.⊠ Certified copies of the priority documen	its have been receive	ed.	
	2. Certified copies of the priority documen	its have been receive	ed in Application No	
* S	3. Copies of the certified copies of the prid application from the International Bo See the attached detailed Office action for a list	ority documents have ureau (PCT Rule 17.	be been received in this National Stage 2(a)).	
	acknowledgment is made of a claim for domest	·		ation).
a;) The translation of the foreign language pr Acknowledgment is made of a claim for domes	ovisional application	has been received.	ŕ
Attachment	i(s)			•
2) Notice	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449) Paper No(s) _	5) 🔲 No	terview Summary (PTO-413) Paper No(s) otice of Informal Patent Application (PTO-152) her:	
S. Patent and Tr PTOL-326 (R		Action Summary	Part of Paper N	 o. 22

DETAILED ACTION

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.

Claims 10-19, 21-22 & 25-52 are rejected under 35 U.S.C. 102(a) as being anticipated by applicant's admitted prior art.

Applicant discloses in the specification that a positional displacement normally occurs during manufacture. Furthermore, admitted prior art, figures 2A and 2B clearly display and thus teach non-alignment.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

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invention was made to a person having ordinary skill in the art to which said subject matter pertains.

Patentability shall not be negatived by the manner in which the invention was made.

Claims 10-19, 21-22 & 25-52 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP(I) (197112 Abstract) in view of Sliwa, Jr. (US Pat. 4,990,462) and Sherry (US Pat. 4,763,829).

JP(I) discloses a mounting method in which a eutectic alloy solder is used to join semiconductor elements to a substrate whereby the soldering is conducted while immersed in an inactive liquid (vapor), thus eliminating oxidation effects JP(I) does not teach the joining of optical devices, semiconductor or ceramic substrates, printed circuit boards, electrodes, the use of ultrasonic vibration, the breaking of surface oxides or specifically the use of a liquid media.

Sliwa, Jr. discloses the use of liquid surface tension to aid in assembly of integrated circuits, optoelectronic devices, with ceramic and semiconductor substrates (abstract; col. 21-22, lines 66-68 & 1-5 and col. 23, lines 16-26). Additionally, it is noted that the one of key mechanisms of the liquid with respect to assembly are the ability of the liquid to render mating segments coplanar in preparation for joining. This is done by a configuration, which seeks the minimum surface tension (col. 13, lines 33-47). The liquid agent helps control the assembly action forces acting on the segments via. surface tension and viscosity selection to minimize mechanical damage (col. 16, lines

40-68). Flotation liquids may be water, methyl or iso-proryl alcohol, molten indium or other low melting point metals and so forth (col. 18, lines 65-69).

The mother substrate may be a semiconductor, metal or insulation material such as glass or ceramic and may disposed on its surface any desirable combination of receptacle segments and conventional hybrid-style components and interconnects (col. 23, lines 16-21). Additionally, conventional solder bumps are shown on flip-chips (col. 23, lines 42-45).

It would have been obvious to one of ordinary skill in the art at the time of the invention to substitute liquid, as taught by Sliwa, Jr., for the JP(I) vapor because they are functional equivalents in terms of carrier media.

It would have been obvious to one or ordinary skill in the art to use semiconductors, optical devices, semiconductor or ceramic substrates, printed circuit boards and electrodes as taught by Sliwa, Jr. because these are merely varieties of semiconductor elements and substrates as used by JP(I).

Sherry discloses a technique for providing solder bumps to electronic components, such as silicon chips, chip carriers and circuit boards. Solder is applied to the surface along with ultrasonic energy so that the solder wets thoroughly (abstract). That is, a wafer is dipped into solder and at the same time ultrasonic energy is applied to the solder by a commercially available ultrasonic horn (col. 3, lines 4-13). The ultrasonic energy serves to break down the surface tension of the solder, thus

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permitting the solder to penetrate the openings in the mask and wet the exposed pads.

Ultrasonic energy also aids in breaking up any oxide on the pad surfaces, thus eliminating the need for a fluxing operation (col. 3, lines 15-21).

It would have been obvious to one of ordinary skill in the art at the time of the invention to use ultrasonic energy for solder bonding as taught by Sherry to the JP(I) soldering operation because it ensures the integrity of the solder joint.

Response to Amendment

Upon carefully reviewing Applicant's arguments filed June 25, 2003 (paper # 21) the Examiner acknowledges the addition of claims 51-52.

Applicant's arguments with respect to claims 10-19, 21-22 & 25-52 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. JP(II) (3060134A, Abstract) & JP(III) (16902, Abstract).

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to M. Alexandra Elve whose telephone number is (703) 308-0092. The examiner can normally be reached Monday to Friday from 6:30 AM to 3:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Dunn, can be reached on (703) 308-3318. The fax number for the group is (703) 872-9386.

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Any inquiry of general nature to the status of this application or proceeding should be directed to the group receptionist whose telephone number is (703) 308-0661.

M. ALEXANDRA ELVE PRIMARY EXAMINER

August 25, 2003.